

AK5730

4-Channel Differential Audio ADC for Line & Mic Inputs

GENERAL DESCRIPTION

The AK5730 is a 4-channel ADC with SAR ADC for DC measurement. The ADC supports Line and Microphone inputs, making it ideal for microphone array applications. TDM audio format makes it easy to connect with DSP.

FEATURES

- 1. Audio ADC
 - 4-Channel Audio ADC
 - Full-differential Input and Single-ended Input
 - Input Voltage:

Microphone: 1.65Vrms,

LINE and Phone: 3Vrms (with external resistors) programmable Boost input: 11.7Vrms (with external resistors) programmable

- ADC Performance:

S/(N+D): typ 92dB DR, S/N: typ 100dB

- Digital HPF for DC-offset cancellation: fc=1Hz with individual on/off
- 2. Sampling Rate: 8kHz ~ 48kHz
- 3. Master Clock: 256fs, 384fs, 512fs or Internal PLL
- 4. Master/Slave mode
- 5. Audio Interface Format: MSB First, 2's complement
 - 24bit I²S
 - 24bit TDM interface up to 2 ICs cascade
- 6. SAR ADC
 - 1ch SAR ADC with 9:1 MUX
 - Reference Voltage: Ground
- 7. Channel Independent Microphone Diagnostics
 - open microphone
 - shorts to battery
 - shorts to ground
 - shorts across inputs
 - microphone bias over current
 - over temperature
- 8. Programmable Microphone Bias: 5V to 9V with 0.5V step
- 9. μP I/F: I²C Bus (Ver 1.0, 400kHz Mode) or SPI
- 10. Power Supply: VDD = 3.0 to 3.6V
- 11. Operating Temperature : Ta = -40 to $105^{\circ}C$
- 12. Package: 48pin LQFP

■ Block Diagram

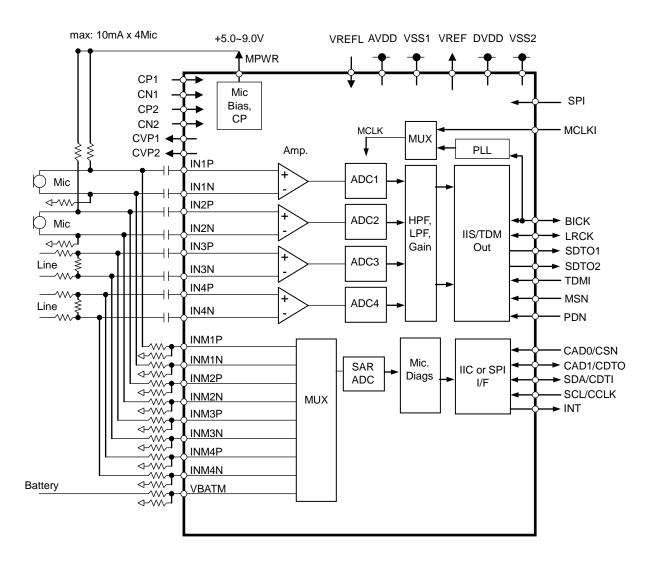
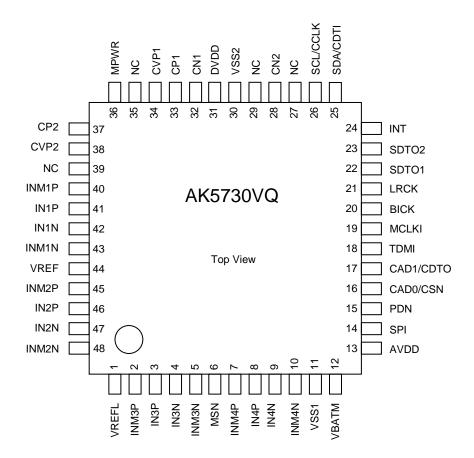


Figure 1. Block Diagram

■ Pin Layout



| | | | PIN/FUNCTION | | |
|-----|-------------|------|---|----------------------|--|
| No. | Pin Name | I/O | Function | Power Down Status | |
| 1 | VREFL | I | ADC Reference Pin. 0V | - | |
| 2 | INM3P | I | Ch3 Positive Input Monitor Pin | Hi-z | |
| 3 | IN3P | I | Ch3 Positive Input Pin (with DC cut capacitor) | Hi-z | |
| 4 | IN3N | I | Ch3 Negative Input Pin (with DC cut capacitor) | Hi-z | |
| 5 | INM3N | I | Ch3 Negative Input Monitor Pin | Hi-z | |
| 6 | MSN | I | Master/Slave Control Pin | Hi-z | |
| 7 | INM4P | I | Ch4 Positive Input Monitor Pin | Hi-z | |
| 8 | IN4P | I | Ch4 Positive Input Pin (with DC cut capacitor) | Hi-z | |
| 9 | IN4N | I | Ch4 Negative Input Pin (with DC cut capacitor) | Hi-z | |
| 10 | INM4N | I | Ch4 Negative Input Monitor Pin | Hi-z | |
| 11 | VSS1 | - | Ground Pin 1. 0V | - | |
| 12 | VBATM | I | Battery Power Monitor Pin | Hi-z | |
| | | | Analog Power Supply Pin, 3.0 ~ 3.6V | | |
| 13 | AVDD | - | Normally connected to VSS1 with a 0.1 µF ceramic capacitor in | - | |
| | | | parallel with a 10μF electrolytic cap. | | |
| 14 | SPI | I | Control Mode Select Pin | Hi-z | |
| 14 | SFI | 1 | "L": I ² C Bus control mode, "H": 4-wire serial control mode | ПІ-Х | |
| | | | Power-Down Mode Pin | | |
| 15 | PDN | I | When at "L", the AK5730 is in the power-down mode and is held in reset. | Hi-z | |
| | | | The AK5730 should always be reset upon power-up. | | |
| | CAD0 | I | (SPI pin = "L") | | |
| 16 | | | Chip Address 0 Pin | Hi-z | |
| | CSN | I | (SPI pin = "H") | | |
| | | | Chip Select Pin in serial control mode (SPI pin = "L") | | |
| | CAD1 | I | Chip Address 1 Pin | | |
| 17 | | | (SPI pin = "H") | Hi-z | |
| | CDTO | O | Control Data Output Pin | | |
| 18 | TDMI | I | TDM Data Input Pin | Hi-z | |
| 19 | MCLKI | I | Master Clock Input Pin | Hi-z | |
| | | | • | Hi-z (Slave) | |
| 20 | BICK | I/O | Audio Serial Data Clock Pin | L Output (Master) | |
| 21 | I DOV | I/O | Channel Cha L D'a | Hi-z (Slave) | |
| 21 | LRCK | I/O | Channel Clock Pin | L Output (Master) | |
| 22 | SDTO1 | О | ADC Audio Serial Data Output1 Pin | L Output | |
| 23 | SDTO2 | О | ADC Audio Serial Data Output2 Pin | L Output | |
| 24 | INT | О | Interrupt Signal Output Pin | Hi-z | |
| 24 | 11.4.1 | 0 | Normally connected to DVDD(3.3V) with an external $10k\Omega$ resistor. | 111-L | |
| | SDA | I/O | (SPI pin = "L") | | |
| 25 | | 1/ 0 | Control Data Input/Output Pin | Hi-z | |
| | CDTI | I | (SPI pin = "H") | <i>2</i> | |
| | | - | Control Data Input Pin | | |
| | SCL | I | (SPI pin = "L") | | |
| 26 | | | Control Data Clock Pin | Hi-z | |
| | CCLK | I | (SPI pin = "H") | 111-2 | |
| 27 | | | Control Data Clock Pin This gin should be compacted to VSS1 | | |
| 27 | NC | - | This pin should be connected to VSS1. | - | |

| No. | Pin Name | I/O | Function | Power Down Status |
|-----|-------------|-----|--|----------------------------|
| 28 | CN2 | Ι | Negative Charge Pump Capacitor Terminal 2 Connect to CP2 with a $2.2\mu F$ low ESR (Equivalent Series Resistance) capacitor over temperature. When this capacitor is polarized, the positive polarity pin should be connected to the CP2 pin. Non-polarized capacitors can also be used. * The maximum bias voltage of this pin is $7.2V$. The capacitance variation of an external capacitor should be in the range of $2.2\mu F + 20\%$ and -40% including the difference by a tolerance, a rate of temperature change and a bias voltage. | 10kΩ Connect to VSS |
| 29 | NC | - | This pin should be connected to VSS1. | = |
| 30 | VSS2 | 1 | Digital Ground Pin and Charge Pump Ground Pin, 0V | = |
| 31 | DVDD | ı | Digital Power Supply Pin and Charge Pump Circuit Positive Power Supply Pin 3.0V~3.6V Normally connected to VSS2 with a 0.1μF ceramic capacitor in parallel with a 10μF electrolytic cap. | - |
| 32 | CN1 | Ι | Negative Charge Pump Capacitor Terminal 1 Connect to CP1 with a $2.2\mu F$ low ESR (Equivalent Series Resistance) capacitor over temperature. When this capacitor is polarized, the positive polarity pin should be connected to the CP1 pin. Non-polarized capacitors can also be used. * The maximum bias voltage of this pin is $3.6V$. The capacitance variation of an external capacitor should be in the range of $2.2\mu F + 20\%$ and -40% including the difference by a tolerance, a rate of temperature change and a bias voltage. | 10kΩ Connect to VSS |
| 33 | CP1 | Ι | Positive Charge Pump Capacitor Terminal 1 Connect to CN1 with a $2.2\mu F$ low ESR (Equivalent Series Resistance) capacitor over temperature. When this capacitor is polarized, the positive polarity pin should be connected to the CP1 pin. Non-polarized capacitors can also be used. * The maximum bias voltage of this pin is $3.6V$. The capacitance variation of an external capacitor should be in the range of $2.2\mu F + 20\%$ and -40% including the difference by a tolerance, a rate of temperature change and a bias voltage. | 50kΩ Connect to VSS |
| 34 | CVP1 | 0 | Charge Pump Circuit Positive Voltage Output Pin 1 Connect to VSS2 with a 2.2µF low ESR (Equivalent Series Resistance) capacitor over temperature. When this capacitor is polarized, the negative polarity pin should be connected to the VSS2 pin. Non-polarized capacitors can also be used. * The maximum bias voltage of this pin is 7.2V. The capacitance variation of an external capacitor should be in the range of 2.2µF +20% and -40% including the difference by a tolerance, a rate of temperature change and a bias voltage. | 50kΩ Connect to AVDD |
| 35 | NC | - | This pin should be connected to VSS1. | - |
| 36 | MPWR | 0 | MIC Power Supply Pin Normally connected to VSS1 with a 1µF ceramic capacitor. * The maximum bias voltage of this pin is 10V. The capacitance variation of an external capacitor should be in the range of 1µF +20% and -40% including the difference by a tolerance, a rate of temperature change and a bias voltage. | Hi-z |

| No. | Pin Name | I/O | Function | Power Down Status |
|-----|-------------|-----|--|---------------------------|
| 37 | CP2 | Ι | Positive Charge Pump Capacitor Terminal Pin 2 Connect to CN2 with a 2.2µF low ESR (Equivalent Series Resistance) capacitor over temperature. When this capacitor is polarized, the positive polarity pin should be connected to the CP2 pin. Non-polarized capacitors can also be used. * The maximum bias voltage of this pin is 7.2V. The capacitance variation of an external capacitor should be in the range of 2.2µF +20% and -40% including the difference by a tolerance, a rate of temperature change and a bias voltage. | 5kΩ Connect to CVP1 |
| 38 | CVP2 | 0 | Charge Pump Circuit Positive Voltage Output Pin 2 Connect to VSS2 with a 2.2µF low ESR (Equivalent Series Resistance) capacitor over temperature. When this capacitor is polarized, the negative polarity pin should be connected to the VSS2 pin. Non-polarized capacitors can also be used. * The maximum bias voltage of this pin is 14.4V. The capacitance variation of an external capacitor should be in the range of 2.2µF +20% and -40% including the difference by a tolerance, a rate of temperature change and a bias voltage. | 5kΩ Connect to CVP1 |
| 39 | NC | - | This pin should be connected to VSS1. | - |
| 40 | INM1P | I | Ch1 Positive Input Monitor Pin | Hi-z |
| 41 | IN1P | I | Ch1 Positive Input Pin (with DC cut capacitor) | Hi-z |
| 42 | IN1N | I | Ch1 Negative Input Pin (with DC cut capacitor) | Hi-z |
| 43 | INM1N | I | Ch1 Negative Input Monitor Pin | Hi-z |
| 44 | VREF | О | Voltage Reference Pin for MPWR. Normally connected to VSS1 with a 1.0μF ceramic capacitor. | 1MΩ Connect to AVDD |
| 45 | INM2P | I | Ch2 Positive Input Monitor Pin | Hi-z |
| 46 | IN2P | I | Ch2 Positive Input Pin (with DC cut capacitor) | Hi-z |
| 47 | IN2N | I | Ch2 Negative Input Pin (with DC cut capacitor) | Hi-z |
| 48 | INM2N | I | Ch2 Negative Input Monitor Pin | Hi-z |

Note 1. All digital input pins should not be left floating. NC Pin (No internal bonding).

ABSOLUTE MAXIMUM RATINGS

(VSS1=VSS2=0V; Note 2)

| Parameter | | Symbol | min | max | Unit |
|-------------------|--------------------------|--------|------|----------|------|
| Power Supplies: | Analog | AVDD | -0.3 | 4.6 | V |
| | Digital, Charge Pump | DVDD | -0.3 | 4.6 | V |
| Input Current, An | y Pin Except Supplies | IIN | - | ±10 | mA |
| Analog Input Vol | tage (Note 3) | VINA | -0.3 | CVP1+0.3 | V |
| Digital Input Vol | tage | VIND | -0.3 | DVDD+0.3 | V |
| Operating Tempe | rature (powered applied) | Ta | -40 | 105 | °C |
| Storage Temperat | ture | Tstg | -65 | 150 | °C |

Note 2. All voltages with respect to ground. VSS1 and VSS2 must be connected to the same analog ground plane.

Note 3. CVP1: CVP1 pin voltage.

The internal positive power supply generating circuit provides positive power supply (CVP1).

| Mode | CVP1 pin Voltage |
|---|------------------|
| Power-down (PDN pin and RSTN bit control) | AVDD |
| Normal operation | 1.67 x AVDD |

CVP1 pin voltage

WARNING: Operation at or beyond these limits may result in permanent damage to the device.

Normal operation is not guaranteed at these extremes.

RECOMMENDED OPERATING CONDITIONS

(VSS1=VSS2 =0V; Note 2)

| Parameter | | Symbol | min | typ | max | Unit |
|----------------|----------------------|--------|-----|-----|-----|------|
| Power Supplies | Analog | AVDD | 3.0 | 3.3 | 3.6 | V |
| (Note 4) | Digital, Charge Pump | DVDD | 3.0 | 3.3 | 3.6 | V |

Note 2. All voltages with respect to ground. VSS1 and VSS2 must be connected to the same analog ground plane.

Note 4. The AVDD, DVDD must be the same voltage.

WARNING: AKM assumes no responsibility for the usage beyond the conditions in this datasheet.

ANALOG CHARACTERISTICS

(Ta=25°C; AVDD=DVDD =3.3V; VSS1=VSS2 =0V; MCLK =512fs, fs=48kHz, BCLK=64fs; Signal Frequency=1kHz; 24bit Data; Measurement frequency=20Hz ~ 20kHz; unless otherwise specified; GAIN bit = "0")

| Parameter | min | typ | max | Unit | |
|-------------------------------------|---------------------------------------|------|------|------|------|
| ADC Analog Ch | aracteristics (AC): | | | | |
| Resolution | · · · | - | - | 24 | Bits |
| | Differential (Note 5) | 1.55 | 1.65 | 1.75 | Vrms |
| Input Voltage | Single-ended (Note 6) | 0.77 | 0.82 | 0.87 | Vrms |
| 1 | Gain mode (Note 7) | 0.51 | 0.55 | 0.59 | Vrms |
| Input Impedance | · · · · · · · · · · · · · · · · · · · | 1.0 | 1.4 | | MΩ |
| | -0.5dBFS Differential | 86 | 92 | - | dB |
| S/(N+D) | -0.5dBFS Single-ended | 86 | 92 | - | dB |
| | -0.5dBFS Gain mode | 86 | 92 | | dB |
| | -60dBFS, A-weighted Differential | 93 | 100 | - | dB |
| Dynamic Range | -60dBFS, A-weighted Single-ended | 92 | 99 | - | dB |
| , , | -60dBFS, A-weighted Gain mode | 92 | 98 | | dB |
| | A-weighted Differential | 93 | 100 | _ | dB |
| S/N | A-weighted Single-ended | 92 | 99 | _ | dB |
| | 10mVrms input, A-weighted Gain mode | 57 | 63 | - | dB |
| Interchannel Isola | | 90 | 100 | - | dB |
| Interchannel Gair | n Mismatch | | 0 | 0.3 | dB |
| | 1kHz, Differential (Note 8) | 70 | 85 | | dB |
| | 20kHz, Differential (Note 8) | 70 | 85 | | dB |
| CMDD | 1kHz, Single-ended (Note 8) | 65 | 80 | | dB |
| CMRR | 20kHz, Single-ended (Note 8) | 55 | 65 | | dB |
| | 1kHz, Gain mode (Note 9) | 65 | 80 | | dB |
| | 20kHz, Gain mode (Note 9) | 65 | 80 | | dB |
| PSRR (1kHz, No | te 10) | | 50 | | dB |
| MIC Power Sup | ply: | | | | |
| | MBS3-0 bits= "0000" | 4.90 | 5 | 5.10 | V |
| | MBS3-0 bits= "0001" | 5.39 | 5.5 | 5.61 | V |
| | MBS3-0 bits= "0010" | 5.88 | 6 | 6.12 | V |
| O 4 4 DCW-14 | MBS3-0 bits= "0011" | 6.37 | 6.5 | 6.63 | V |
| Output DC Volta (Note 11) | MBS3-0 bits= "0100" | 6.86 | 7 | 7.14 | V |
| (Note 11) | MBS3-0 bits= "0101" | 7.35 | 7.5 | 7.65 | V |
| | MBS3-0 bits= "0110" | 7.84 | 8 | 8.16 | V |
| | MBS3-0 bits= "0111" | 8.33 | 8.5 | 8.67 | V |
| | MBS3-0 bits="1000" | 8.78 | 9 | 9.22 | V |
| Microphone Current (for 4 channels) | | 0.1 | | 40 | mA |
| Output Noise Level (A-weighted) | | | -100 | -94 | dBV |
| SAR ADC Char | acteristics (DC): | | | | |
| Resolution | | - | - | 12 | Bits |
| Input Voltage (N | ote 12) | 3.2 | 3.3 | 3.4 | V |
| Integral Nonlinea | * ' ' | -4 | | +5 | LSB |
| Differential Nonl | inearity (DNL) Error | -2 | | +2 | LSB |

- Note 5. The voltage difference between IN*P and IN*N pins. Input Voltage should be adjusted with external resistors. Input voltage is proportional to AVDD voltage. Vin = $0.5 \times \text{AVDD Vrms}$ (typ). (*=1,2,3,4)
- Note 6. In single-ended input mode, IN*P pin, IN*N pin must be connected to signal common. Input Voltage should be adjusted with external resistors. When STD* bit = "1", Input voltage is proportional to AVDD voltage. (*=1,2,3,4) $Vin = 0.25 \times AVDD \ Vrms$ (typ).
- Note 7. The voltage difference between IN*P and IN*N pins. Input Voltage should be adjusted with external resistors. When GAIN* bit = "1", Input Voltage = 0.55Vrms = $0.167 \times AVDD$ Vrms (typ). (*=1,2,3,4)
- Note 8. The 1kHz, 1.0Vpp signal is applied to IN*N and IN*P with same phase. CMRR is measured as the attenuation level from 0dB = -7.5dBFS(since the normal 1Vpp= -7.5dBFS). (*=1,2,3,4)
- Note 9. The 1kHz, 0.5Vpp signal is applied to IN+. An IN- pin must be connected to the signal common. CMRR is measured as the attenuation level from 0dB = -4dBFS(since the normal 1Vpp=-4dBFS).

- Note 10. The PSRR is applied to AVDD and DVDD with 1kHz, 100mVpp.
- Note 11. When MBS3-0 bits = "0000" / "0001" / "0010" / "0010" / "0100" / "0101" / "0110" / "0111" / "1000", the output DC Voltage(typ) is $1.52 / 1.67 / 1.82 / 1.97 / 2.12 / 2.27 / 2.42 / 2.58 / 2.73 \times AVDD(V)$, respectively. when MBS3-0 bits = "0000" / "0001" / "0010" / "0011" / "0100" / "0110" / "0110" / "0111", the output DC Voltage (min, max) is $\pm 2.0\%$ of Output DC Voltage(typ).
 - when MBS3-0 bits = "1000", Output DC Voltage(min, max) is $\pm 2.5\%$ of Output DC Voltage (typ).
- Note 12. Input Voltage should be adjusted with external resistors. The input voltage range is from 0 to AVDD. $Vin = 1.00 \times AVDD$ (Vpp). The SAR ADC operates at more than 100 mV.

FILTER CHARACTERISTICS

(Ta=25°C; AVDD=DVDD=3.0~3.6V; VSS1=VSS2 =0V; fs=48kHz)

| Parameter | | | Symbol | min | typ | max | Unit |
|---------------------------|-------------|---------|--------|-----|------|-------|------|
| ADC Digital Filter (Dec | imation LPF | T): | | | | | |
| Passband | (Note 13) | ±0.13dB | PB | 0 | | 18.0 | kHz |
| | | -0.2dB | | - | 19.4 | - | kHz |
| | | -3.0dB | | - | 22.8 | - | kHz |
| Stopband | | | SB | 28 | - | - | kHz |
| Passband Ripple | | | PR | - | - | ±0.04 | dB |
| Stopband Attenuation | | | SA | 68 | - | - | dB |
| Group Delay | (Note 14) | | GD | - | 16.4 | - | 1/fs |
| Group Delay Distortion | | | ΔGD | - | 0 | - | μs |
| ADC Digital Filter (HPF): | | | | | | | |
| Frequency Response | (Note 13) | -3dB | FR | - | 1.0 | - | Hz |
| | | -0.1dB | | - | 7.1 | - | Hz |

Note 13. The passband and stopband frequencies scale with fs.

For example, 19.4kHz (@-0.2dB)= $0.404 \times fs$

Note 14. The calculating delay time which occurred by digital filtering. This time is from setting the input of analog signal to setting the 24bit data of both channels to the output register.

DC CHARACTERISTICS

(Ta=-40 ~+105°C; AVDD=DVDD=3.0~3.6V; VSS1=VSS2 =0V)

| Parameter | Symbol | min | typ | max | Unit |
|---|--------|----------|-----|---------|------|
| High-Level Input Voltage | VIH | 70%DVDD | - | - | V |
| Low-Level Input Voltage | VIL | - | - | 30%DVDD | V |
| High-Level Output Voltage (Iout=-400μA) | VOH | DVDD-0.4 | - | - | V |
| Low-Level Output Voltage | VOL | - | | 0.4 | V |
| (Iout= 400μA(except SDA, INT pin), | | | | | |
| 3mA(SDA, INT pin)) | | | | | |
| Input Leakage Current | Iin | - | - | ±10 | μΑ |

(Ta=25°C; AVDD=DVDD=3.3V; VSS1=VSS2 =0V)

| Power Supplies | | | | |
|--|-----|-----|------|------|
| Parameter | min | typ | max | Unit |
| Power Supply Current | | | | |
| Normal Operation (PDN pin = "H") | | | | |
| DVDD (Microphone Current=40mA) | - | 183 | 225 | mA |
| DVDD (Microphone Current=100uA) | - | 22 | 36 | mA |
| AVDD | - | 9 | 13.5 | mA |
| Power-Down Mode (PDN pin = "L"; Note 15) | | | | |
| DVDD | - | 3 | 20 | μΑ |
| AVDD | - | 0 | 20 | μA |

Note 15. All digital inputs including clock pins (MCLKI, BICK, LRCK and TDMI) are held at DVDD or VSS2.

SWITCHING CHARACTERISTICS

(Ta=-40~+105°C; AVDD=DVDD=3.0~3.6V; VSS1=VSS2 =0V; C_L=20pF)

| Parameter | | Symbol | min | typ | max | Unit |
|---------------------------|-----------|--------|---------|-------|--------|------|
| Master Clock Timing | | | | | | |
| External Clock | | | | | | |
| 256fs: | | fCLK | 2.048 | - | 12.288 | MHz |
| Pulse Width Low | | tCLKL | 32 | - | - | ns |
| Pulse Width High | | tCLKH | 32 | - | - | ns |
| 384fs: | | fCLK | 3.072 | - | 18.432 | MHz |
| Pulse Width Low | | tCLKL | 22 | - | - | ns |
| Pulse Width High | | tCLKH | 22 | - | - | ns |
| 512fs: | | fCLK | 4.096 | - | 24.576 | MHz |
| Pulse Width Low | | tCLKL | 16 | - | - | ns |
| Pulse Width High | | tCLKH | 16 | - | - | ns |
| LRCK Timing (Slave mode) | | | | | | |
| Stereo mode | | | | | | |
| (TDM1/0 bit = "00") | | | | | | |
| frequency | | fs | 8 | - | 48 | kHz |
| Duty Cycle | | Duty | 45 | - | 55 | % |
| TDM256 mode | (Note 16) | | | | | |
| (TDM1/0 bit = "01") | | | | | | |
| LRCK frequency | | fs | 8 | - | 48 | kHz |
| "H" time | | tLRH | 1/256fs | - | - | ns |
| "L" time | | tLRL | 1/256fs | - | - | ns |
| LRCK Timing (Master Mode) | | | | | | |
| Stereo mode | | | | | | |
| (TDM1/0 bit = "00") | | | | | | |
| Normal Speed Mode | | fs | 8 | - | 48 | kHz |
| Duty Cycle | | Duty | - | 50 | - | % |
| TDM256 mode | (Note 16) | | | | | |
| (TDM1/0 bit = "01") | | | | | | |
| LRCK frequency | | fs | 8 | - | 48 | kHz |
| "H" time | (Note 17) | tLRH | - | 1/8fs | - | ns |

Note 16. Master clock should be input the 256fs/512fs in Master mode.

Note 17. If the format is I^2S , it is "L" time.

| Parameter | Symbol | min | typ | max | Unit |
|--|--------|------|-------|-----|------|
| Audio Interface Timing (Slave mode) | | | | | |
| Stereo mode (TDM1/0 bit = "00") | | | | | |
| BICK Period | tBCK | 320 | - | - | ns |
| BICK Pulse Width Low | tBCKL | 128 | - | - | ns |
| Pulse Width High | tBCKH | 128 | - | - | ns |
| LRCK Edge to BICK "\" (Note 18) | tLRB | 20 | - | - | ns |
| BICK "↑" to LRCK Edge (Note 18) | tBLR | 20 | - | - | ns |
| LRCK Edge to SDTO(MSB)(Except I ² S mode) | tLRS | - | - | 20 | ns |
| BICK "↓" to SDTO | tBSD | - | - | 20 | ns |
| TDM256 mode (TDM1/0 bit = "01") | | | | | |
| BICK Period | tBCK | 80 | - | - | ns |
| BICK Pulse Width Low | tBCKL | 32 | - | - | ns |
| Pulse Width High | tBCKH | 32 | - | - | ns |
| LRCK Edge to BICK "\" (Note 18) | tLRB | 20 | - | - | ns |
| BICK "↑" to LRCK Edge (Note 18) | tBLR | 20 | - | - | ns |
| SDTO Setup time BICK "↑" | tBSS | 16.3 | - | - | ns |
| SDTO Hold time BICK "↑" | tBSH | 16.3 | - | - | ns |
| TDMI Hold Time | tSDH | 10 | - | - | ns |
| TDMI Setup Time | tSDS | 10 | - | - | ns |
| Audio Interface Timing (Master mode) | | | | | |
| Stereo mode (TDM1/0 bit = "00") | | | | | |
| BICK Frequency | fBCK | - | 64fs | - | Hz |
| BICK Duty | dBCK | - | 50 | - | % |
| BICK "↓" to LRCK | tMBLR | -20 | - | 20 | ns |
| BICK "↓" to SDTO | tBSD | -20 | - | 20 | ns |
| TDM256 mode (TDM1/0 bit = "01") | | | | | |
| BICK Frequency | fBCK | - | 256fs | - | Hz |
| BICK Duty | dBCK | - | 50 | - | % |
| BICK "↓" to LRCK | tMBLR | -20 | | 20 | ns |
| SDTO Setup time BICK "\"" | tBSS | 16.3 | - | _ | ns |
| SDTO Hold time BICK "\" | tBSH | 16.3 | - | - | ns |
| TDMI Hold Time | tSDH | 10 | - | - | ns |
| TDMI Setup Time | tSDS | 10 | - | - | ns |

Note 18. BICK rising edge must not occur at the same time as LRCK edge.

| Parameter | Symbol | min | typ | max | Unit |
|--|-----------------------|-----|------|-----|------|
| Control Interface Timing (4-wire serial mode) | | | | | |
| CCLK Period | tCCK | 200 | - | - | ns |
| CCLK Pulse Width Low | tCCKL | 80 | - | - | ns |
| CCLK Pulse Width High | tCCKH | 80 | - | - | ns |
| CDTI Setup Time | tCDS | 50 | - | - | ns |
| CDTI Hold Time | tCDH | 50 | - | - | ns |
| CSN "H" Time | tCSW | 150 | - | - | ns |
| CSN "↓" to CCLK "↑" | tCSS | 50 | - | - | ns |
| CCLK "↑" to CSN "↑" | tCSH | 50 | - | - | ns |
| CDTO Delay | tDCD | - | - | 45 | ns |
| CSN "↑" to CDTO Hi-Z | tCCZ | - | - | 70 | ns |
| Control Interface Timing (I ² C Bus): | | | | | |
| SCL Clock Frequency | fSCL | - | - | 400 | kHz |
| Bus Free Time Between Transmissions | tBUF | 1.3 | - | - | μs |
| Start Condition Hold Time (prior to first clock pulse) | tHD:STA | 0.6 | - | - | μs |
| Clock Low Time | tLOW | 1.3 | - | - | μs |
| Clock High Time | tHIGH | 0.6 | - | - | μs |
| Setup Time for Repeated Start Condition | tSU :STA | 0.6 | - | - | μs |
| SDA Hold Time from SCL Falling (Note 19) | tHD :DAT | 0 | - | - | μs |
| SDA Setup Time from SCL Rising | tSU :DAT | 0.1 | - | - | μs |
| Rise Time of Both SDA and SCL Lines | tR | - | - | 1.0 | μs |
| Fall Time of Both SDA and SCL Lines | tF | - | - | 0.3 | μs |
| Setup Time for Stop Condition | tSU:STO | 0.6 | - | - | μs |
| Pulse Width of Spike Noise Suppressed by Input Filter | tSP :I ² C | 0 | - | 50 | ns |
| Capacitive load on bus | Cb | - | - | 400 | pF |
| Power-down & Reset Timing | | | | | |
| PDN Pulse Width (Note 20) | tPD | 150 | - | - | ns |
| PDN "↑" to SDTO valid (FS1/0bit="00") (Note 21) | tPDV | - | 3153 | - | 1/fs |
| PDN "↑" to SDTO valid (FS1/0bit="01") (Note 21) | | - | 2098 | - | 1/fs |
| PDN "↑" to SDTO valid (FS1/0bit="10") (Note 21) | | - | 1729 | - | 1/fs |
| Pulse Width of Spike Noise Suppressed by Input Filter | tSP :PD | 0 | - | 20 | ns |

Note 19. Data must be held for sufficient time to bridge the 300 ns transition time of SCL.

Note 20. The AK5730 can be reset by setting the PDN pin to "L" upon power-up.

Note 21. These cycles are the numbers of LRCK rising edges from the PDN pin rising.

Note 22. I²C-bus is a trademark of NXP B.V.

■ Timing Diagram

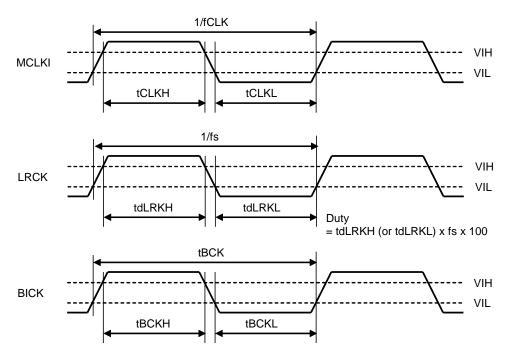


Figure 2. Clock Timing (TDM1/0 bits = "00" & Slave mode)

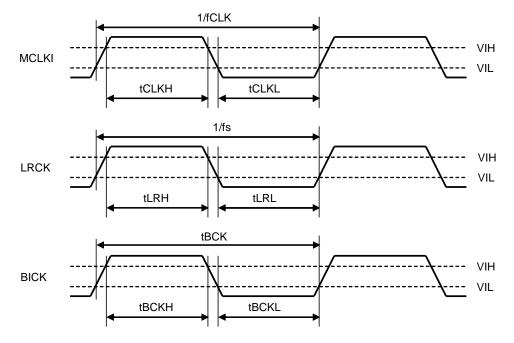


Figure 3. Clock Timing (Except TDM1/0 bits = "00" & Slave mode)

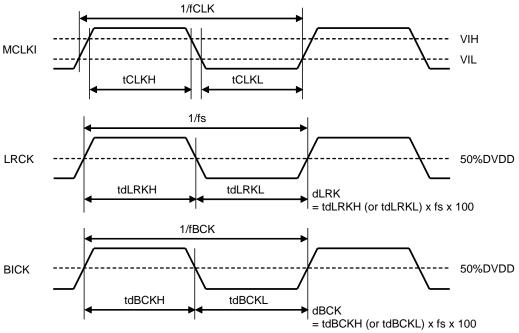


Figure 4. Clock Timing (TDM1/0 bits = "00" & Master mode)

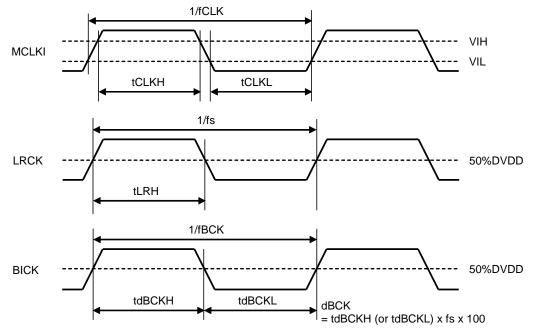


Figure 5. Clock Timing (Except TDM1/0 bits = "00" & Master mode)

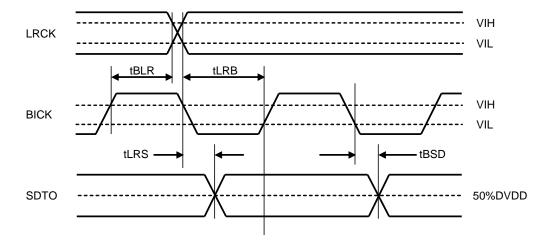


Figure 6. Audio Interface Timing (TDM1/0 bits = "00" & Slave mode)

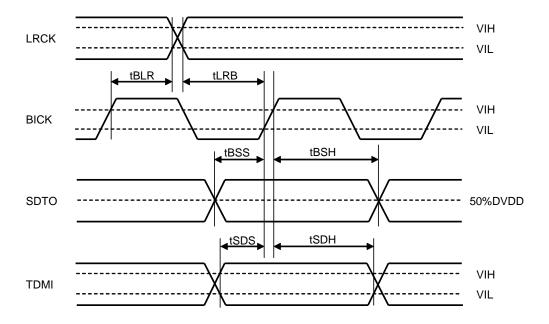


Figure 7. Audio Interface Timing (Except TDM1/0 bits = "00" & Slave mode)

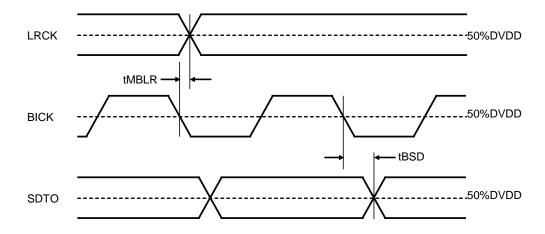


Figure 8. Audio Interface Timing (TDM1/0 bits = "00" & Master mode)

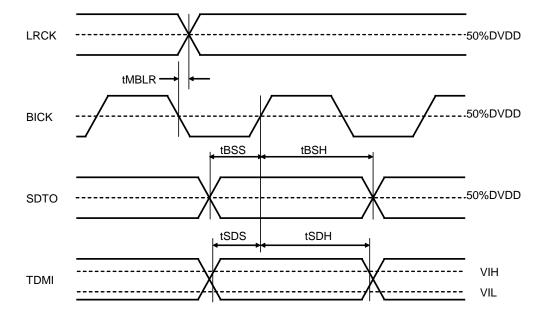


Figure 9. Audio Interface Timing (Except TDM1/0 bits = "00" & Master mode)

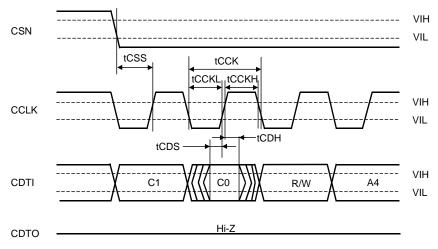


Figure 10. WRITE/READ command input timing (4-wire serial mode)

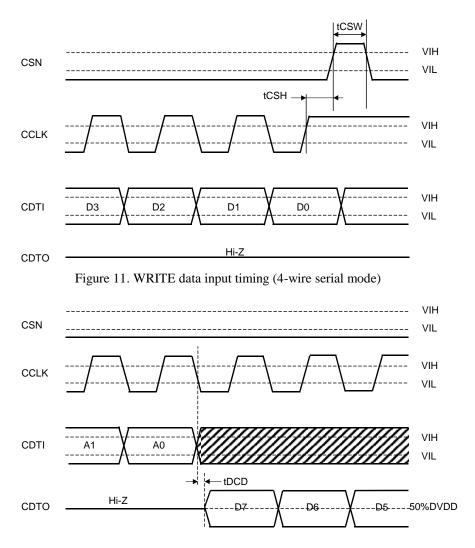


Figure 12. READ data output timing 1 (4-wire serial mode)

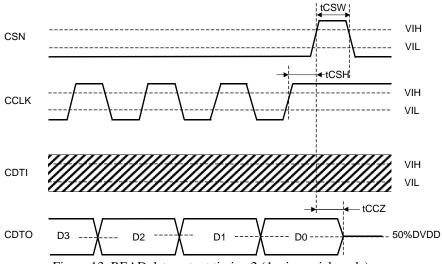


Figure 13. READ data output timing 2 (4-wire serial mode)

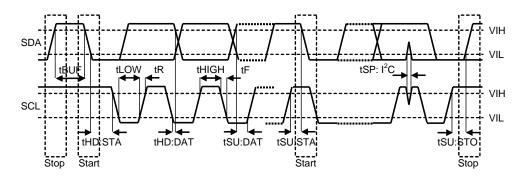


Figure 14. I²C Bus Timing

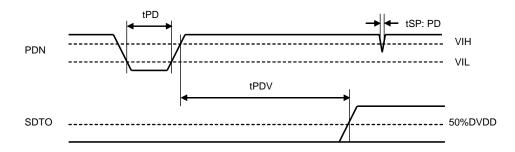


Figure 15. Power-down & Reset Timing

OPERATION OVERVIEW

■ System Clock

The MSN pin selects either master or slave mode. MSN pin = "H" selects master mode and "L" selects slave mode.

In slave mode, required clocks depend on use of the internal PLL (PLL1-0 bits).

(1) Not using PLL

MCLK, BICK and LRCK (fs) are required. MCLKI should be synchronized with LRCK but the phase is not critical. After exiting reset at power-up in slave mode, the AK5730 is in power-down mode until MCLK, LRCK and BICK are input.

(2) Using PLL

BICK and LRCK are required. After exiting reset at power-up in master mode, the AK5730 is in power-down mode until MCLKI are input.

Table 1 shows the relationship between the sampling rate and the frequencies of MCLK and BICK. The sampling speed is set by FS0 and FS1 bits (Table 3).

In master mode, only MCLKI is required. Master Clock Input Frequency should be set with the CKS1-0 bits (Table 2), and the sampling speed should be set by the FS1-0 bits. After exiting reset at power-up in master mode, the AK5730 is in power-down mode until MCLKI are input. In TDM256 mode, the master clock should be 256fs.

| LRCK | MCLK (MHz) | | | BICK (MHz) |
|---------|------------|---------|---------|------------|
| fs | 256fs | 384fs | 512fs | 64fs |
| 8kHz | 2.048 | 3.072 | 4.096 | 0.512 |
| 32kHz | 8.192 | 12.288 | 16.384 | 2.048 |
| 44.1kHz | 11.2896 | 16.9344 | 22.5792 | 2.8224 |
| 48kHz | 12.288 | 18.432 | 24.576 | 3.072 |

Table 1. System Clock Example

| CKS1 bit | CKS0 bit | Clock Speed | |
|----------|----------|-------------|-----------|
| 0 | 0 | 256fs | |
| 0 | 1 | 384fs | |
| 1 | 0 | 512fs | (default) |
| 1 | 1 | (reserved) | |

Table 2. Master Clock Control (Master Mode)

| FS1 bit | FS0 bit | Sampling Rate | |
|---------|---------|-------------------------|-----------|
| 0 | 0 | 24kHz – 48kHz | (default) |
| 0 | 1 | 12kHz – 24kHz | |
| 1 | 0 | 8kHz – 12kHz | |
| 1 | 1 | 8kHz – 12kHz (reserved) | |

Table 3. Sampling Rate (fs)

■ Master Mode and Slave Mode

Master Mode and Slave Mode are selected by setting the MSN pin. ("H"=Master Mode, "L"=Slave Mode) In master mode (MSN pin= "H"), LRCK pin and BICK pin are output pins. In slave mode (MSN pin= "L"), LRCK pin and BICK pins are input pins

PLL1-0 bits control the PLL modes which generates the internal MCLK from BICK.

| PDN | MSN pin | PLL1 bit | PLL0 bit | LRCK pin | BICK pin |
|-----|---------|----------|----------|------------|------------------------|
| L | L | * | * | Input | Input |
| L | Н | * | * | "L" Output | "L" Output |
| Н | L | 0 | 0 | Input | Input (PLL off) |
| Н | L | 0 | 1 | Input | 64fs Input (PLL mode) |
| Н | L | 1 | 0 | Input | 256fs Input (PLL mode) |
| Н | L | 1 | 1 | Input | 512fs Input (PLL mode) |
| Н | Н | * | * | Output | Output |

(*: Don't Care)

Table 4. LRCK and BICK pins

■ Digital High Pass Filter (HPF)

The ADC has digital high pass filters for DC offset cancellation. The cut-off frequency of the HPF is 1.0Hz at fs=48kHz and scales with the sampling rate (fs).

HPFs are controlled by the HPE4-1 bits.

| HPE1 bit | HPF | |
|----------|--------------|-----------|
| L | ADC1 HPF off | |
| Н | ADC1 HPF on | (default) |

| HPE2 bit | HPF | |
|----------|--------------|-----------|
| L | ADC2 HPF off | |
| H | ADC2 HPF on | (default) |

| HPE3 bit | HPF | |
|----------|--------------|-----------|
| L | ADC3 HPF off | |
| Н | ADC3 HPF on | (default) |

| HPE4 bit | HPF | |
|----------|--------------|-----------|
| L | ADC4 HPF off | |
| Н | ADC4 HPF on | (default) |

Table 5. HPF Operation Setting

■ Audio Serial Interface Format

Four types of the date formats are available and selected by setting the DIF bit and the TDM1-0 bits. In all modes, the serial data is MSB first, 2's complement format. LRCK and BICK are output in master mode, input in slave mode. In slave mode, the MCLKI clock frequency is allowed 256fs and 512fs. In master mode, the MCLKI clock frequency should be 256fs.

| Mode | DIF bit | TDM1 bit | TDM0 bit | BICK | Data Format |] |
|------|---------|----------|----------|-------|--------------------------------|-----------|
| 0 | 0 | 0 | 0 | 64fs | Stereo Mode (I ² S) | (default) |
| 1 | 0 | 0 | 1 | 256fs | TDM256 Mode(I ² S) | |
| - | 0 | 1 | 0 | - | (Reserved) | |
| - | 0 | 1 | 1 | - | (Reserved) | |
| 3 | 1 | 0 | 0 | 64fs | Stereo Mode (Left Justified) | |
| 4 | 1 | 0 | 1 | 256fs | TDM256 Mode (Left Justified) | |
| - | 1 | 1 | 0 | - | (Reserved) | |
| - | 1 | 1 | 1 | - | (Reserved) | |

Table 6. TDM Mode Setting

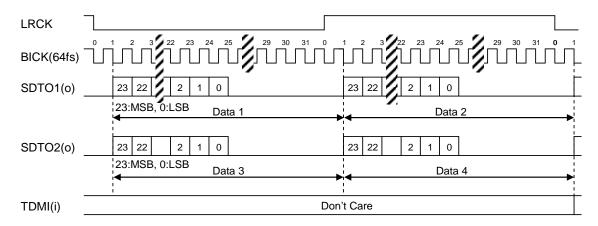


Figure 16. Mode 0 Timing (Stereo Mode (I²S))

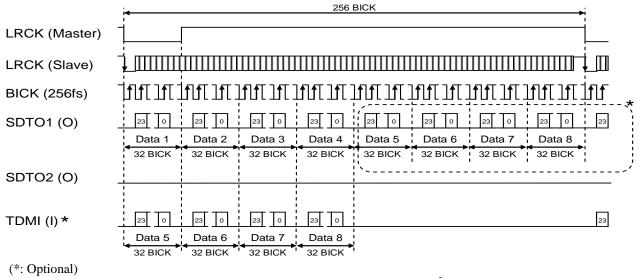


Figure 17. Model Timing (TDM256 Mode (I²S))

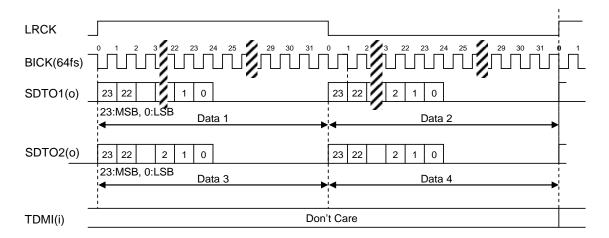


Figure 18. Mode3 Timing (Stereo Mode (Left Justified))

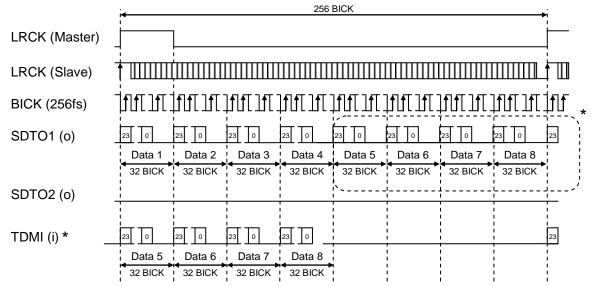


Figure 19. Mode4 Timing (TDM256 Mode (Left Justified))

■ TDM Cascade Mode

TDM256 mode

Two devices can be connected in cascades at the TDM256 mode. In Figure 20, the SDTO1 pin of device #1 is connected with the TDMI pin of device #2. It is possible to output 8channel TDM data from the SDTO1 pin of device # 2 as shown in Figure 17 and Figure 19.

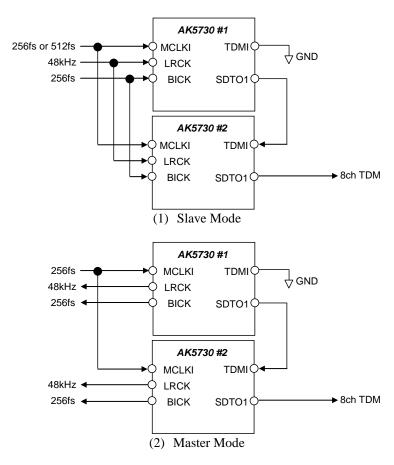


Figure 20. Cascade TDM Connection Diagram (TDM256 mode)

■ System Reset

The AK5730 should be reset once by bringing the PDN pin = "L" upon power-up. The AK5730 is powered up and the internal timing starts clocking by LRCK "\" after exiting the power down state of reference voltage (such as VREF) by MCLKI. In slave mode, the AK5730 is in power-down mode until MCLK, BICK and LRCK are input. In master mode, the AK5730 is in power-down mode until MCLKI is input. Following all clock inputs, set RSTN bit to "1" after setting microphone bias voltage (MBS3-0 bits).

■ Digital Attenuator

The AK5730 has a channel-independent digital attenuator (256 levels, 0.5dB step). Attenuation level of each channel can be set by each the ATT7-0 bits (Table 7).

| ATT7-0 | Attenuation Level |
|--------|-------------------|
| 00H | +12dB |
| 01H | +11.5dB |
| • | : |
| 18H | 0dB(default) |
| 19H | -0.5dB |
| 1AH | -1.0dB |
| | : |
| FEH | -115.0dB |
| FFH | MUTE $(-\infty)$ |

Table 7. Attenuation level of digital attenuator

Transition time between set values of ATT7-0 bits can be selected by ATS1-0 bits (Table 8). Transition between set values is the soft transition eliminating a switching noise in the transition.

| Mode | ATS1 | ATS0 | ATT speed | |
|------|------|------|-----------|-----------|
| 0 | 0 | 0 | 3712/fs | (default) |
| 1 | 0 | 1 | 928/fs | |
| 2 | 1 | 0 | 1856/fs | |
| 3 | 1 | 1 | 7424/fs | |

Table 8. Transition Time between Set Values of ATT7-0 bits

The transition between set values is a soft transition of 3712 levels in mode 0. It takes 3712/fs (77.3ms@fs=48kHz) from 00H(+12dB) to FFH(MUTE). If the PDN pin goes to "L", the ATTs are initialized to 18H. The ATTs also become 18H when RSTN bit = "0", and fade to their current value when RSTN bit returns to "1".

■ Analog Input Mode

The AK5730 has 4 Analog Input modes. Analog Input mode is controlled by LIN*1-0 bits. The input mode is fixed by each set. The AC signal is input from IN*P/N, and the DC signal is input from INM*P/N. Except for Microphone Input mode, the input voltage of IN*P/N(=1.65Vrms (Typ.), Differential) should be adjusted with external resistors. As for the accuracy of external resistance, 0.1% is required for CMRR.

The input voltage of INM*P/N(=AVDD) should be adjusted with external resistors. Fault conditions are calculated digitally, so the value of external resistance is fixed to 7:3. The input voltage of INM*P/N becomes 30% of VDC+/-. As for the accuracy of external resistance, 0.1% is required for the accuracy of SAR.

The full scale of SAR is normalized to 11V (@AVDD=3.3V) for calculations of Fault Condition detection.

(A) Microphone Input Mode (LIN*1-0 bits = "00")

The microphones are connected in a fully balanced manner. A separate cable shield for each microphone may be connected to chassis ground. In this use case, a gain correction of 9.5dB by GAIN* bit = "1" is available.

| Parameter | Specification | Remarks |
|--------------------------------|---------------------------|---------------------------------|
| Mic Impedance | 1 - 2kΩ, 10 kΩ(max) | |
| Mic Audio Output | 10100mVrms, 1.75Vrms(max) | |
| Interchannel Isolation(max) of | 70dB | |
| Microphone inputs | | |
| Mic Phantom Voltage(Vbias) | 5V - 9V | depending on type of microphone |
| Mic Supply Current | 0.1 - 10mA | per microphone |
| | | depending on type of microphone |
| Resistors (symmetrical) | 200 - 10k | |

Table 9. Specification(Microphone Input mode)

The maximum interchannel isolation of microphone inputs is 70dB. The isolation depends on MPWR common impedance. In Figure 21, the microphone impedance and the microphone bias resistance is $2k\Omega$ and MPWR voltage is 8.0V. At this time, MPWR common impedance should be 0.2Ω or less.

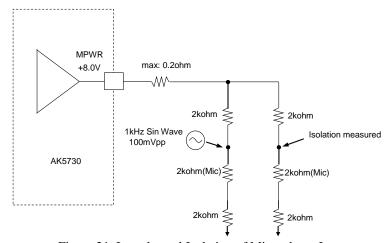


Figure 21. Interchannel Isolation of Microphone Inputs

Different types of microphones can be connected at the same time, with the same phantom voltage.

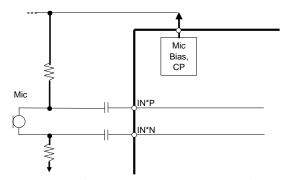


Figure 22. Microphone Input Mode(IN*P/N pins)

For Fault Conditions, refer to Table 10 and Figure 23.

| Fault Conditions | Conditions |
|---|---|
| Positive/Negative input shorted to VBAT | VDC+/- ≥Vbias + Vth |
| Positive/Negative input shorted to GND | $VDC+/- \leq Vth$ |
| Pos. and neg. inputs shorted | $ VDC+ - VDC- \le Vth$ |
| Positive input open | $Vbias - Vth \le VDC + \le Vbias + Vth$ |
| Negative input open | $VDC+/- \le Vth$ |

Note 23. It is not possible to distinguish "Positive/Negative input shorted to GND" and "Negative input open". Vth: Error Monitor Threshold Voltage. Vth is set by Table 18.

Table 10. Fault Conditions (Microphone Input Mode)

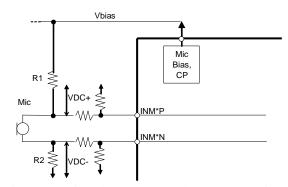


Figure 23. Microphone Input Mode (IN*MP/N pins)

(B) LINE and Phone Input Mode (LIN*1-0 bits = "01")

The stereo line input is a quasi-differential input. Line return, phone return and head unit ground may be isolated from each other. Also combinations of two stereo line inputs, one stereo line and one stereo phone inputs are possible.

| Parameter | Specification | Remarks |
|---------------------------|---------------|-------------------------|
| Stereo Line Input Voltage | 1 - 3V RMS | (depending on customer) |
| Phone Input Voltage | 0.1 - 3V RMS | (depending on customer) |

Table 11 Specification (LINE and Phone Input mode)

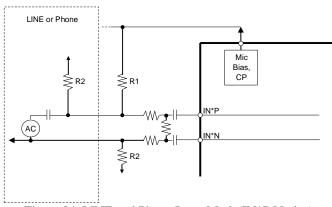


Figure 24. LINE and Phone Input Mode(IN*P/N pins)

For Fault Conditions, refer to Table 12 and Figure 25. The "Pos. and neg. inputs shorted State (R2/(2R1+R2)) * Vbias" is detected based on SAR Threshold A(THA12-01 bits).

The threshold A is a 12bit straight binary code which the full scale is 11V.

| Fault Conditions | Conditions |
|---------------------------------------|--|
| Positive/Negative input short to VBAT | $VDC+/- \ge Vbias + Vth$ |
| Positive/Negative input short to GND | $VDC+/- \le Vth$ |
| Pos. and neg. inputs short | $R2/(2R1+R2) * Vbias -Vth \le VDC + \approx$ |
| | $VDC- \le R2/(2R1+R2) * Vbias + Vth$ |
| Positive input open | Vbias - Vth \leq VDC+ \leq Vbias + Vth |
| Negative input open | $VDC+/- \le Vth$ |

Note 23. It is not possible to distinguish "Positive/Negative input shorted to GND" and "Negative input open".

Note 24. The "Pos. and neg. inputs short" is a condition that occurs when there is no input signal, and DC voltage is not supplied by the input signal.

Table 12. Fault Conditions (LINE and Phone Input Mode)

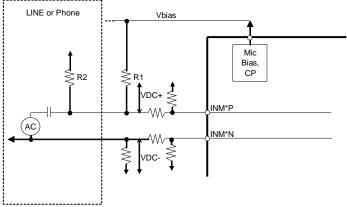


Figure 25. LINE and Phone Input Mode (IN*MP/N pins)

(C) Booster Input Mode (LIN*1-0 bits = "10")

The booster inputs are directly driven by a standard automotive power amp, either by a class AB, a class SB (I) or even by a class D amplifier. The connection is made in a fully balanced manner. In case of using a class SB (I) amplifier, the input voltage may contain common mode signal inside the audio bandwidth due to switching from bridge to single ended mode and vice versa. Booster inputs may share a Quad-ADC with any other input type (line, phone and microphone).

| | Parameter | Specification | Remarks |
|---|--------------------|---------------|--------------------------|
| I | Input voltage typ. | 10.0V RMS | @ battery voltage <14.4V |
| | Input voltage max. | 11.7V RMS | @ battery voltage =16.5V |

Table 13 Specification (Booster Input mode)

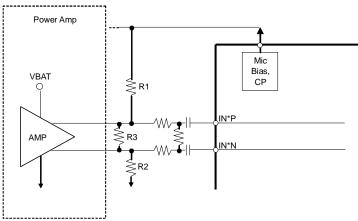


Figure 26. Booster Input mode (IN*P/N pins)

Diagnostic functions are performed by the external amplifier. A simple check can be made, whether the input is connected or not. Input is connected to amp output: VDC+=VDC-=VBAT/2. Refer to Note 25 and Figure 27 about Fault Conditions. The "Input open State ((R2+R3)/(R1+R2+R3) * Vbias) and (R2/(R1+R2+R3) * Vbias)" are detected based on SAR threshold B and C (THB12-01 bits, THC12-01 bits). The threshold B and C are 12bit straight binary codes, which the full scale is 11V (Typ.).

| Fault Conditions | Conditions |
|---------------------|--|
| Positive input open | $(R2+R3)/(R1+R2+R3) * Vbias -Vth \le VDC+ \le (R2+R3)/(R1+R2+R3) * Vbias +Vth$ |
| Negative input open | $R2/(R1+R2+R3) * Vbias - Vth \le VDC- \le R2/(R1+R2+R3) * Vbias + Vth$ |

Note 25. Positive/Negative input open conditions are statuses when there is no input signal and DC voltage is not supplied by the input signal.

Table 14 Fault Conditions (Booster Input mode)

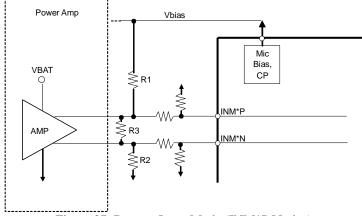


Figure 27. Booster Input Mode (INM*P/N pins)

(D) Internal Unbalanced Source Mode (LIN*1-0 bits = "11") Max. unbalanced input voltage < 2V RMS In this mode, No diagnosis is performed for internal connections.

■ VBATM pin

The input voltage of the VBATM pin should be adjusted with external resistors as below. The input voltage range is 0 to AVDD. When the input is AVDD voltage (=3.3V typ.), the SAR outputs Full-scale data(typ.)

ex.) AVDD=3.3V R1=2 $M\Omega$, $R2=360k\Omega$

When Battery voltage is 21.6V, the voltage at VBATM pin becomes 3.3V and the SAR outputs Full-scale data. Battery = $21.6V \rightarrow Full$ -scale

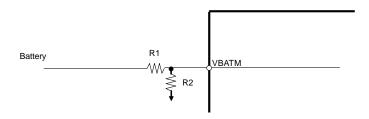


Figure 28. VBATM pin

■ Error Detection

The following seven events cause the INT pin to show the status of the fault condition. When the PDN pin is "L", the INT pin goes to "Hi-z".

- 1. OPEN: Open circuit
- 2. SHTD: Short between the positive and negative microphone input
- 3. SHTG: Short to ground
- 4. SHTV: Short to VBAT
- 5. OVCR1: Mic Bias Over-current(90mA(typ)) of booster
- 6. OVCR2: Charge Pump Over-current(600mA(typ)) of booster
- 7. OVTP: Over-temp(165 degrees(typ)) of booster

The INT pin outputs an ORed signal based on the above seven interrupt events. When error information is masked, the interrupt event does not affect the operation of the INT pin. This pin should be connected to DVDD (typ. 3.3V) or lower voltage via a $10k\Omega$ resistor.

Once the INT pin goes to "L", it remains "L" until writing INTR bit = "1". After writing "1" to INTR bit, it automatically returns to "0".

OPEN, SHTD, SHTG, SHTV, OVCR and OVTP bits in Address 07-0BH indicate the interrupt status events above in real time. Once they go to "1", it stays "1" until writing INTR bit = "1".

When MSHTV*, MSHTG*, MSHTD*, MOPEN* (*: 1-4) bits (Address=0C-0FH) go to "1", error information at SHTV*, SHTG*, SHTD*, OPEN* bits can not be masked but does not affect the operation of the INT pin. (Table 16)

When over-temperature (OVTP) or over-current (OVCR1, OVCR2) is detected, the AK5730 disables the block listed on Table 15. Unless the error is due to over-temperature or over-current, error detection is restarted by writing INTR bit = "1". When the error is due to over-temperature or over-current, restart the AK5730 by the PDN pin or RSTN bit.

| INT detection | CPUIF | PLL | CP | MIC Bias | ADC | SAR ADC | MIC Diags |
|-------------------|-------|-----|----|----------|-----|---------|-----------|
| SAR ERR | Α | Α | Α | Α | Α | А | Α |
| TSD Overtemp. | А | А | L | А | - | А | Α |
| MIC overcurrent + | А | А | L | А | - | А | А |
| MIC overcurrent - | А | А | - | - | - | - | - |
| CP overcurrent | Α | А | L | А | - | - | - |

A: Active Block, L: Active in Low Power Mode, x: Power Down

Table 15. Block Conditions on Error Detection

| Unmasked Event | Masked Event | INT pin |
|----------------|-----------------------|--|
| Not detected | Not detected DETECTED | Hi-Z |
| DETECTED | DETECTED | L (goes "Hi-Z" after writing INTR bit = "1") |

Table 16. Error Handling in Serial Control Mode

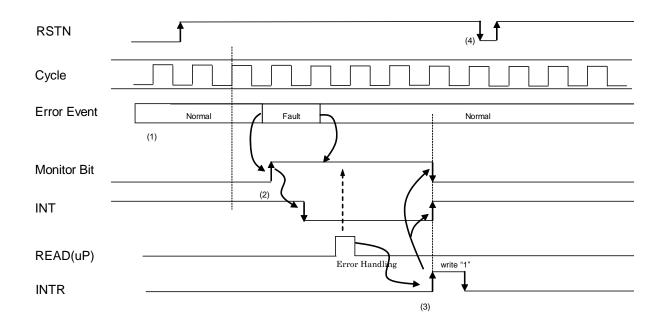


Figure 29. Error Detection Timing

Notes:

- (1) Execute error detection from 1ch to 8ch (IN1P~IN4P, IN1N~IN4N pins) in this order.
- (2) After the error detection from 1ch to 8ch, the error detection results are ORed and reflected to INT pins. Indication of INT pins can be masked by MSHTV*, MSHTG*, MSHTD*, MOPEN* (*: 1-4) bits (Address= 0C-0FH).
- (3) Error monitor registers are reset by setting INTR bit to "1" after all error conditions are removed.
- (4) When the detected error is due to over-temperature or over-current, restart the AK5730 by the PDN pin or RSTN bit.

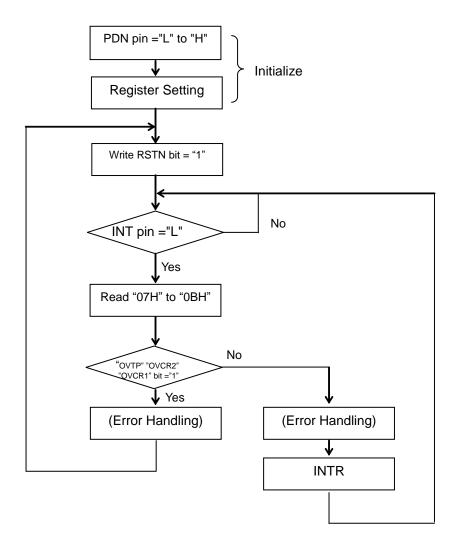


Figure 30. Error Handling Sequence Example

■ Power Up/Down Sequence

The each block of the AK5730 is placed in power-down mode by bringing the PDN pin to "L" and both digital filters are reset at the same time. The PDN pin ="L" also resets the control registers to their default values. In power-down mode, the SDTO pin goes to "L". This reset must always be executed after power-up.

In slave mode, after exiting reset at power-up and etc., the ADC starts operation from the rising edge of LRCK after MCLKI inputs. The AK5730 is in power-down mode until MCLK and LRCK and BICK are input.

The analog initialization cycle of ADC starts after exiting the power-down mode. Therefore, the output data, SDTO becomes available after 1041/fs cycles of LRCK clock. Figure 31 shows the sequences of the power-down and the power-up.

When RSTN bit = "0", all circuits are powered-down but the internal register are not initialized.

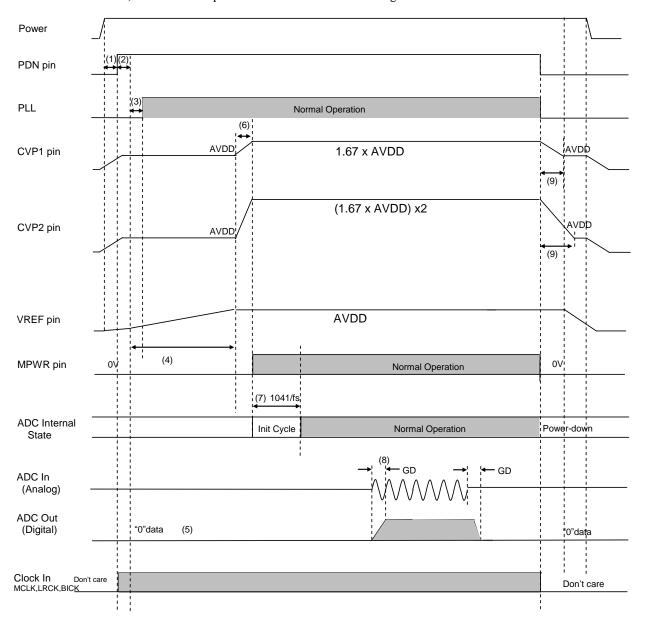


Figure 31 Power-up/down Sequence Example

Notes:

(1) Power-up the AK5730 during the PDN pin = "L". The PDN pin should be set to "H" after all powers (DVDD, AVDD) are supplied. The AK5730 requires 150ns or longer "L" period for a certain reset.

- (2) Set RSTN bit to "1" after setting microphone bias voltage (MBS3-0 bits).
- (3) Power-on the PLL circuit:(PLL mode)

PLL1-0 bits = "01" or "10" or "11", & BICK is input.

PLL is locked within 1 - 2ms

(4) Power-on the Vref circuit:

The CVP1 pin and CVP2 pin are charged up.

The VREF pin becomes AVDD within about 20 - 40ms.

- (5) ADC outputs "0" data in power-down state.
- (6) Power-on the charge pump circuit 1/2:

 $(Normal\ mode)\ PDN\ pin = \text{``L''} \rightarrow \text{``H''} (or\ PLL\ is\ locked)\ \&\ MCLKI,\ BICK,\ LRCK\ is\ input. (normal\ mode)$

(PLL mode) PLL is locked.

The CVP1 pin becomes 1.67 x AVDD within about 4 - 8ms.

The CVP2 pin becomes (1.67 x AVDD) x 2 within about 4 - 8ms.

- (7) The analog block of ADC is initialized after exiting the power-down state.
- (8) Digital outputs corresponding to analog inputs-has group delay (GD).
- (9) Charge pump circuit power down:

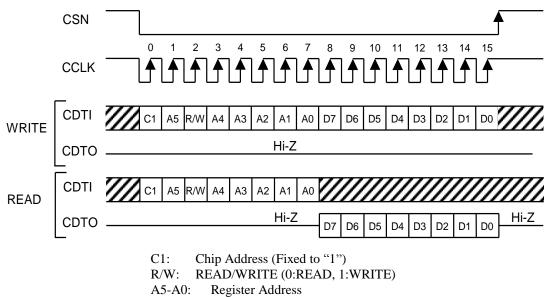
PDN pin = "H" **→** "L"

The CVP1/2 pin becomes AVDD according to a flying capacitor and internal resistor. The internal resistor is $50k\Omega$ (typ). Therefore, when the CVP1/2 pin has a flying capacitor of $2.2\mu F$, the time constant is 110ms (typ).

■ Serial Control Interface

(1) 4-wire Serial Control Mode (SPI pin = "H")

The internal registers may be either written or read by the 4-wire μP interface pins: CSN, CCLK, CDTI & CDTO. The data on this interface consists of Chip address (1bit, C1 is fixed to "1"), Read/Write (1bit), Register address (MSB first, 6bits) and Control data (MSB first, 8bits). Address and data is clocked in on the rising edge of CCLK and data is clocked out on the falling edge. For write operations, data is latched after the 16th rising edge of CCLK, after a high-to-low transition of CSN. For read operations, the CDTO output goes high impedance after a low-to-high transition of CSN. The maximum speed of CCLK is 5MHz. The PDN pin= "L" resets the registers to their default values.



D7-D0: Control Data

Figure 32. 4-wire Serial Control I/F Timing

(2). I^2C bus control mode (SPI pin = "L")

The AK5730 supports the fast-mode I²C-bus (max: 400kHz).

(2)-1. WRITE Operations

Figure 33 shows the data transfer sequence of the I²C-bus mode. All commands are preceded by a START condition. A HIGH to LOW transition on the SDA line while SCL is HIGH indicates a START condition (Figure 39). After the START condition, a slave address is sent. This address is 7 bits long followed by the eighth bit that is a data direction bit (R/W). The most significant five bits of the slave address are fixed as "00100". The next bits are CAD1 and CAD0 (device address bit). This bit identifies the specific device on the bus. The hard-wired input pins (CAD1/0 pins) set these device address bits (Figure 34). If the slave address matches that of the AK5730, the AK5730 generates an acknowledge and the operation is executed. The master must generate the acknowledge-related clock pulse and release the SDA line (HIGH) during the acknowledge clock pulse (Figure 40). R/W bit = "1" indicates that the read operation is to be executed. "0" indicates that the write operation is to be executed.

The second byte consists of the control register address of the AK5730. The format is MSB first, and those most significant 2-bits are fixed to zeros (Figure 35). The data after the second byte contains control data. The format is MSB first, 8bits (Figure 36). The AK5730 generates an acknowledge after each byte is received. Data transfer is always terminated by a STOP condition generated by the master. A LOW to HIGH transition on the SDA line while SCL is HIGH defines a STOP condition (Figure 39).

The AK5730 can perform more than one byte write operation per sequence. After receipt of the third byte the AK5730 generates an acknowledge and awaits the next data. The master can transmit more than one byte instead of terminating the write cycle after the first data byte is transferred. After receiving each data packet the internal 6-bit address counter is incremented by one, and the next data is automatically taken into the next address. If the address exceeds 2DH prior to generating a stop condition, the address counter will "roll over" to 00H and the previous data will be overwritten.

The data on the SDA line must remain stable during the HIGH period of the clock. The HIGH or LOW state of the data line can only be changed when the clock signal on the SCL line is LOW (Figure 41) except for the START and STOP conditions.

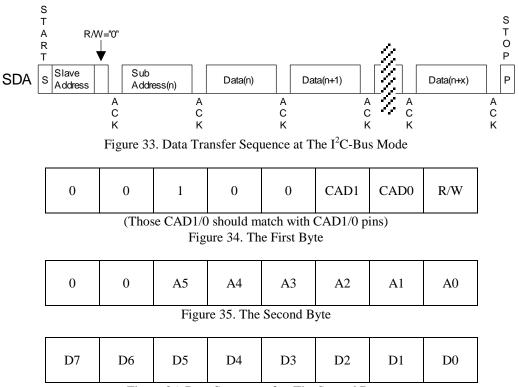


Figure 36. Byte Structure after The Second Byte

(2)-2. READ Operations

Set the R/W bit = "1" for the READ operation of the AK5730. After transmission of data, the master can read the next address's data by generating an acknowledge instead of terminating the write cycle after the receipt of the first data word. After receiving each data packet the internal 6-bit address counter is incremented by one, and the next data is automatically taken into the next address. If the address exceeds 2DH prior to generating a stop condition, the address counter will "roll over" to 00H and the data of 00H will be read out.

The AK5730 supports two basic read operations: CURRENT ADDRESS READ and RANDOM ADDRESS READ.

(2)-2-1. CURRENT ADDRESS READ

The AK5730 contains an internal address counter that maintains the address of the last word accessed, incremented by one. Therefore, if the last access (either a read or write) was to address "n", the next CURRENT READ operation would access data from the address "n+1". After receipt of the slave address with R/W bit "1", the AK5730 generates an acknowledge, transmits 1-byte of data to the address set by the internal address counter and increments the internal address counter by 1. If the master does not generate an acknowledge but generates a stop condition instead, the AK5730 ceases transmission.

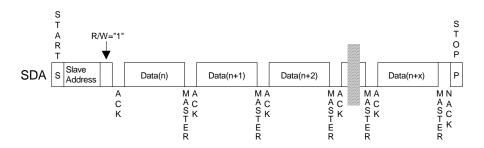


Figure 37. CURRENT ADDRESS READ

(2)-2-2. RANDOM ADDRESS READ

The random read operation allows the master to access any memory location at random. Prior to issuing a slave address with the R/W bit = "1", the master must execute a "dummy" write operation first. The master issues a start request, a slave address (R/W bit = "0") and then the register address to read. After the register address is acknowledged, the master immediately reissues the start request and the slave address with the R/W bit = "1". The AK5730 then generates an acknowledge, 1 byte of data and increments the internal address counter by 1. If the master does not generate an acknowledge but generates a stop condition instead, the AK5730 ceases transmission.

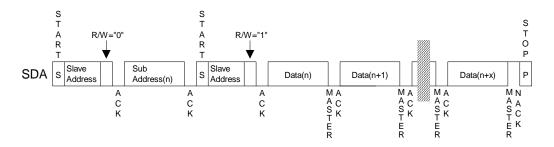


Figure 38. RANDOM ADDRESS READ

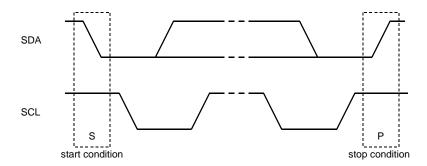


Figure 39. START and STOP Conditions

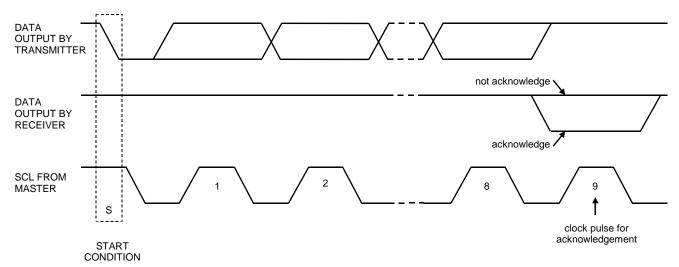


Figure 40. Acknowledge on the I²C-Bus

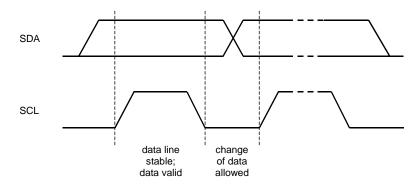


Figure 41. Bit Transfer on the I²C-Bus

■ Register Map

| 4.11 | D. C. M. | D.7 | D. | D.5 | D.4 | D2 | D2 | D.I | D.O. |
|------|------------------------|-------|-------|-------|-------|--------|--------|--------|--------|
| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| 00H | General Setting 1 | CKS1 | CKS0 | ATS1 | ATS0 | DIF | TDM1 | TDM0 | RSTN |
| 01H | General Setting 2 | MBS3 | MBS2 | MBS1 | MBS0 | FS1 | FS0 | PLL1 | PLL0 |
| 02H | Input mode | LIN41 | LIN40 | LIN31 | LIN30 | LIN21 | LIN20 | LIN11 | LIN10 |
| 03H | ADC1 Volume Control | ATT17 | ATT16 | ATT15 | ATT14 | ATT13 | ATT12 | ATT11 | ATT10 |
| 04H | ADC2 Volume Control | ATT27 | ATT26 | ATT25 | ATT24 | ATT23 | ATT22 | ATT21 | ATT20 |
| 05H | ADC3 Volume Control | ATT37 | ATT36 | ATT35 | ATT34 | ATT33 | ATT32 | ATT31 | ATT30 |
| 06H | ADC4 Volume Control | ATT47 | ATT46 | ATT45 | ATT44 | ATT43 | ATT42 | ATT41 | ATT40 |
| 07H | Monitor Summary | 0 | 0 | 0 | 0 | ADC4 | ADC3 | ADC2 | ADC1 |
| 08H | Monitor ADC1 | 0 | OVTP | OVCR2 | OVCR1 | SHTV1 | SHTG1 | SHTD1 | OPEN1 |
| 09H | Monitor ADC2 | 0 | 0 | 0 | 0 | SHTV2 | SHTG2 | SHTD2 | OPEN2 |
| 0AH | Monitor ADC3 | 0 | 0 | 0 | 0 | SHTV3 | SHTG3 | SHTD3 | OPEN3 |
| 0BH | Monitor ADC4 | 0 | 0 | 0 | 0 | SHTV4 | SHTG4 | SHTD4 | OPEN4 |
| 0CH | Mask ADC1 | 0 | 0 | 0 | 0 | MSHTV1 | MSHTG1 | MSHTD1 | MOPEN1 |
| 0DH | Mask ADC2 | 0 | 0 | 0 | 0 | MSHTV2 | MSHTG2 | MSHTD2 | MOPEN2 |
| 0EH | Mask ADC3 | 0 | 0 | 0 | 0 | MSHTV3 | MSHTG3 | MSHTD3 | MOPEN3 |
| 0FH | Mask ADC4 | 0 | 0 | 0 | 0 | MSHTV4 | MSHTG4 | MSHTD4 | MOPEN4 |
| 10H | Threshold setting OPEN | 0 | 0 | 0 | 0 | TOP4 | TOP3 | TOP2 | TOP1 |
| 11H | Threshold setting SHTD | 0 | 0 | 0 | 0 | TSD4 | TSD3 | TSD2 | TSD1 |
| 12H | Threshold setting SHTG | 0 | 0 | 0 | 0 | TSG4 | TSG3 | TSG2 | TSG1 |
| 13H | Threshold setting SHTV | 0 | 0 | 0 | 0 | TSV4 | TSV3 | TSV2 | TSV1 |
| 14H | INT setting | STD4 | STD3 | STD2 | STD1 | 0 | 0 | 0 | INTR |
| 15H | ADC HPF | GAIN4 | GAIN3 | GAIN2 | GAIN1 | HPF4 | HPF3 | HPF2 | HPF1 |
| 16H | SAR Thresh A High byte | THA12 | THA11 | THA10 | THA09 | THA08 | THA07 | THA06 | THA05 |
| 17H | SAR Thresh A Low byte | THA04 | THA03 | THA02 | THA01 | 0 | 0 | 0 | 0 |
| 18H | SAR Thresh B High byte | THB12 | THB11 | THB10 | THB09 | THB08 | THB07 | THB06 | THB05 |
| 19H | SAR Thresh B Low byte | THB04 | THB03 | THB02 | THB01 | 0 | 0 | 0 | 0 |
| 1AH | SAR Thresh C High byte | THC12 | THC11 | THC10 | THC09 | THC08 | THC07 | THC06 | THC05 |
| 1BH | SAR Thresh C Low byte | THC04 | THC03 | THC02 | THC01 | 0 | 0 | 0 | 0 |
| 1CH | SAR IN1+ High byte | 1P12 | 1P11 | 1P10 | 1P09 | 1P08 | 1P07 | 1P06 | 1P05 |
| 1DH | SAR IN1+ Low byte | 1P04 | 1P03 | 1P02 | 1P01 | 0 | 0 | 0 | 0 |
| 1EH | SAR IN1- High byte | 1N12 | 1N11 | 1N10 | 1P09 | 1N08 | 1N07 | 1N06 | 1N05 |
| 1FH | SAR IN1- Low byte | 1N04 | 1N03 | 1N02 | 1N01 | 0 | 0 | 0 | 0 |
| 20H | SAR IN2+ High byte | 2P12 | 2P11 | 2P10 | 2P09 | 2P08 | 2P07 | 2P06 | 2P05 |
| 21H | SAR IN2+ Low byte | 2P04 | 2P03 | 2P02 | 2P01 | 0 | 0 | 0 | 0 |
| 22H | SAR IN2- High byte | 2N12 | 2N11 | 2N10 | 2N09 | 2N08 | 2N07 | 2N06 | 2N05 |
| 23H | SAR IN2- Low byte | 2N04 | 2N03 | 2N02 | 2N01 | 0 | 0 | 0 | 0 |
| 24H | SAR IN3+ High byte | 3P12 | 3P11 | 3P10 | 3P09 | 3P08 | 3P07 | 3P06 | 3P05 |
| 25H | SAR IN3+ Low byte | 3P04 | 3P03 | 3P02 | 3P01 | 0 | 0 | 0 | 0 |
| 26H | SAR IN3- High byte | 3N12 | 1N11 | 3N10 | 3P09 | 3N08 | 3N07 | 3N06 | 3N05 |
| 27H | SAR IN3- Low byte | 3N04 | 3N03 | 3N02 | 3N01 | 0 | 0 | 0 | 0 |
| 28H | SAR IN4+ High byte | 4P12 | 4P11 | 4P10 | 4P09 | 4P08 | 4P07 | 4P06 | 4P05 |
| 29H | SAR IN4+ Low byte | 4P04 | 4P03 | 4P02 | 4P01 | 0 | 0 | 0 | 0 |
| 2AH | SAR IN4- High byte | 4N12 | 4N11 | 2N10 | 4N09 | 4N08 | 4N07 | 4N06 | 4N05 |
| 2BH | SAR IN4- Low byte | 4N04 | 4N03 | 4N02 | 4N01 | 0 | 0 | 0 | 0 |
| 2CH | SAR VBAT High byte | VB12 | VB11 | VB10 | VB09 | VB08 | VB07 | VB06 | VB05 |
| 2DH | SAR VBAT Ingil byte | VB12 | VB03 | VB02 | VB07 | 0 | 0 | 0 | 0 |
| 2DH | SAK YDAI LUW UYK | V DU4 | א סטט | V DU2 | 1001 | U | U | U | U |

Note: For addresses from 2EH to 3FH, data is not written.

When the PDN pin goes to "L", all registers are initialized to their default values.

When RSTN bit is set to "0", the internal timing is reset, but registers are not initialized to their default values.

■ Register Definitions

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|-----------------|------|------|------|------|-----|------|------|------|
| 00H | General Setting | CKS1 | CKS0 | ATS1 | ATS0 | DIF | TDM1 | TDM0 | RSTN |
| | R/W | | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

RSTN: Internal timing reset

0: Reset. Registers are not initialized. (default)

1: Normal operation

TDM1-0: TDM Mode Select (Table 6)

00: Normal mode. (default)

01: TDM256 mode

10: Reserved

11: Reserved

DIF: Data format setting (Table 6)

0: I²S. (default)

1: Left Justified

ATS1-0: Digital attenuator transition time setting (Table 8)

Default: "00", mode 0

CKS1-0: Master Clock setting in Master

mode. Refer to Table 2

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|-------------------|------|------|------|------|-----|-----|------|------|
| 01H | General Setting 2 | MBS3 | MBS2 | MBS1 | MBS0 | FS1 | FS0 | PLL1 | PLL0 |
| | R/W | | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

PLL1-0: PLL mode setting (Table 4)

00: Normal mode. PLL off. (default)

01: PLL mode (BICK=64fs)

10: PLL mode (BICK=256fs)

11: PLL mode (BICK=512fs)

FS1-0: Sampling Frequency setting (Table 3)

00: 24k-48kHz (default)

01: 12k-24kHz

10: 8k-12kHz

11: (Reserved)

(default)

MBS3-0: Mic bias voltage setting

| MBS3-0 | Bias Voltage |
|-------------|--------------------------|
| 00H | 5V |
| 01H | 5.5V |
| 02H | 6V |
| 03H | 6.5V |
| 04H | 7V |
| 05H | 7.5V |
| 06H | 8V |
| 07H | 8.5V |
| 08H | 9 V |
| 09H | Hi-Z |
| 0AH-0FH | (reserved) |
| Table 17. M | IIC Bias Voltage Setting |

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|---------------|-------|-------|-------|-------|-------|-------|-------|-------|
| 02H | Input mode | LIN41 | LIN40 | LIN31 | LIN30 | LIN21 | LIN20 | LIN11 | LIN10 |
| | R/W | | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

LIN*1-*0: Mic/Line select for each ADC*

00: Mic mode (Default)01: LINE and Phone mode

10: Booster input mode

11: Internal unbalanced sources mode. No diagnosis is performed for internal connections.

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|---------------------|-------|-------|-------|-------|-------|-------|-------|-------|
| 03H | ADC1 Volume Control | ATT17 | ATT16 | ATT15 | ATT14 | ATT13 | ATT12 | ATT11 | ATT10 |
| 04H | ADC2 Volume Control | ATT27 | ATT26 | ATT25 | ATT24 | ATT23 | ATT22 | ATT21 | ATT20 |
| 05H | ADC3 Volume Control | ATT37 | ATT36 | ATT35 | ATT34 | ATT33 | ATT32 | ATT31 | ATT30 |
| 06H | ADC4 Volume Control | ATT47 | ATT46 | ATT45 | ATT44 | ATT43 | ATT42 | ATT41 | ATT40 |
| | R/W | | R/W |
| Default | | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 0 |

ATT*7-*0: ADC* Volume Control

Refer to Table 7.

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|-----------------|----|----|----|----|------|------|------|------|
| 07H | Monitor Summary | 0 | 0 | 0 | 0 | ADC4 | ADC3 | ADC2 | ADC1 |
| | R/W | RD | RD | RD | RD | RD | RD | RD | RD |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

ADC4-1: Error Monitor for each ADC

0: No error detected.

1: Error detected. Returns to "L" when INTR bit = "1".

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|---------------|----|------|-------|-------|-------|-------|-------|-------|
| 08H | Monitor ADC1 | 0 | OVTP | OVCR2 | OVCR1 | SHTV1 | SHTG1 | SHTD1 | OPEN1 |
| 09H | Monitor ADC2 | 0 | 0 | 0 | 0 | SHTV2 | SHTG2 | SHTD2 | OPEN2 |
| 0AH | Monitor ADC3 | 0 | 0 | 0 | 0 | SHTV3 | SHTG3 | SHTD3 | OPEN3 |
| 0BH | Monitor ADC4 | 0 | 0 | 0 | 0 | SHTV4 | SHTG4 | SHTD4 | OPEN4 |
| | R/W | RD | RD | RD | RD | RD | RD | RD | RD |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Error Monitor.

0: No error detected.

1: Error detected. Set ADCx bit "1" if unmasked.

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|---------------|-----|-----|-----|-----|--------|--------|--------|--------|
| 0CH | Mask ADC1 | 0 | 0 | 0 | 0 | MSHTV1 | MSHTG1 | MSHTD1 | MOPEN1 |
| 0DH | Mask ADC2 | 0 | 0 | 0 | 0 | MSHTV2 | MSHTG2 | MSHTD2 | MOPEN2 |
| 0EH | Mask ADC3 | 0 | 0 | 0 | 0 | MSHTV3 | MSHTG3 | MSHTD3 | MOPEN3 |
| 0FH | Mask ADC4 | 0 | 0 | 0 | 0 | MSHTV4 | MSHTG4 | MSHTD4 | MOPEN4 |
| | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Error Monitor Mask.

0: No mask.

1: Mask error.

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|------------------------|----|----|----|----|------|------|------|------|
| 10H | Threshold setting OPEN | 0 | 0 | 0 | 0 | TOP3 | TOP2 | TOP1 | TOP0 |
| 11H | Threshold setting SHTD | 0 | 0 | 0 | 0 | TSD3 | TSD2 | TSD1 | TSD0 |
| 12H | Threshold setting SHTG | 0 | 0 | 0 | 0 | TSG3 | TSG2 | TSG1 | TSG0 |
| 13H | Threshold setting SHTV | 0 | 0 | 0 | 0 | TSV3 | TSV2 | TSV1 | TSV0 |
| | R/W | RD | RD | RD | RD | R/W | R/W | R/W | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |

Error Monitor Threshold Setting

Threshold Voltage is proportional to AVDD voltage. This value is set in digital code.

The threshold voltage is a 12bit straight binary code which the full scale is AVDD/0.3 (11V@AVDD=3.3V). The monitored voltage is multiplied by 0.3 by an external resistor and input to the voltage monitoring pin. Therefore, the threshold voltage range is from $+100mV \times 0.3$ (=+30mV) to $+900mV \times 0.3$ (=+270mV) at the input pin.

| bit3-0 | Threshold Voltage | |
|---------|-------------------|----------|
| 00H | +100mV | |
| 01H | +200mV | |
| 02H | +300mV | (default |
| 03H | +400mV | |
| 04H | +500mV | |
| 05H | +600mV | |
| 06H | +700mV | |
| 07H | +800mV | |
| 08H | +900mV | |
| 09H-0FH | (Reserved) | |

Table 18. Error Monitor Threshold Setting

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|---------------|------|------|------|------|----|----|----|------|
| 14H | INT setting | STD4 | STD3 | STD2 | STD1 | 0 | 0 | 1 | INTR |
| | R/W | R/W | R/W | R/W | R/W | RD | RD | RD | R/W |
| | Default | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |

INTR: INT pin reset

0: Normal operation (default)

1: Reset. Error Monitor Registers(07-0BH) are initialized.

STD1-4: ADC1-4 Mode setting

0: Differential mode (default)

1: Single-ended mode.

When STD* bit = "1", Single-ended IN*P pin, IN*N pin must be connected to signal common.

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|---------------|-------|-------|-------|-------|------|------|------|------|
| 15H | ADC HPF | GAIN4 | GAIN3 | GAIN2 | GAIN1 | HPF4 | HPF3 | HPF2 | HPF1 |
| R/W | | R/W | R/W | R/W | R/W | R/W | R/W | R/W | R/W |
| Default | | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 |

HPF4-1: ADC1-4 HPF on/off (Table 5)

0:ADC* HPF off

1:ADC* HPF on (default)

GAIN4-1: ADC1-4 Differential input Voltage setting

0: 1.65Vrms (default)

1: 0.55Vrms.

When GAIN*bit = "1", input voltage is amplified threefold (+9.5dB)

In order to adjust full scale range to that of the default condition,

attenuation level of each channel should be set at -9.5dB by the ATT7-0 bits (Table 7).

| Addr | Register Name | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|---------|--------------------------|-------|-------|-------|-------|-------|-------|-------|-------|
| 16H | SAR Thresh A High byte | THA12 | THA11 | THA10 | THA09 | THA08 | THA07 | THA06 | THA05 |
| 17H | SAR Thresh A Low byte | THA04 | THA03 | THA02 | THA01 | 0 | 0 | 0 | 0 |
| 18H | SAR Thresh B High byte | THB12 | THB11 | THB10 | THB09 | THB08 | THB07 | THB06 | THB05 |
| 19H | SAR Thresh B Low byte | THB04 | THB03 | THB02 | THB01 | 0 | 0 | 0 | 0 |
| 1AH | SAR Thresh C High byte | THC12 | THC11 | THC10 | THC09 | THC08 | THC07 | THC06 | THC05 |
| 1BH | BH SAR Thresh C Low byte | | THC03 | THC02 | THC01 | 0 | 0 | 0 | 0 |
| R/W | | R/W |
| Default | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

SAR Raw Data Threshold A/B/C.

A: Pos. and neg. inputs shorted in LINE and Phone mode.

B: Input open in Booster input mode.

C: Input open in Booster input mode.

| Addr | Addr Register Name | | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
|-----------------------|--------------------|------|------|------|------|------|------|------|------|
| 1CH | SAR IN1+ High byte | 1P12 | 1P11 | 1P10 | 1P09 | 1P08 | 1P07 | 1P06 | 1P05 |
| 1DH | SAR IN1+ Low byte | 1P04 | 1P03 | 1P02 | 1P01 | 0 | 0 | 0 | 0 |
| 1EH | SAR IN1- High byte | 1N12 | 1N11 | 1N10 | 1P09 | 1N08 | 1N07 | 1N06 | 1N05 |
| 1FH | SAR IN1- Low byte | 1N04 | 1N03 | 1N02 | 1N01 | 0 | 0 | 0 | 0 |
| 20H | SAR IN2+ High byte | 2P12 | 2P11 | 2P10 | 2P09 | 2P08 | 2P07 | 2P06 | 2P05 |
| 21H | SAR IN2+ Low byte | 2P04 | 2P03 | 2P02 | 2P01 | 0 | 0 | 0 | 0 |
| 22H | SAR IN2- High byte | 2N12 | 2N11 | 2N10 | 2N09 | 2N08 | 2N07 | 2N06 | 2N05 |
| 23H | SAR IN2- Low byte | 2N04 | 2N03 | 2N02 | 2N01 | 0 | 0 | 0 | 0 |
| 24H | SAR IN3+ High byte | 3P12 | 3P11 | 3P10 | 3P09 | 3P08 | 3P07 | 3P06 | 3P05 |
| 25H | SAR IN3+ Low byte | 3P04 | 3P03 | 3P02 | 3P01 | 0 | 0 | 0 | 0 |
| 26H | SAR IN3- High byte | 3N12 | 1N11 | 3N10 | 3P09 | 3N08 | 3N07 | 3N06 | 3N05 |
| 27H | SAR IN3- Low byte | 3N04 | 3N03 | 3N02 | 3N01 | 0 | 0 | 0 | 0 |
| 28H | SAR IN4+ High byte | 4P12 | 4P11 | 4P10 | 4P09 | 4P08 | 4P07 | 4P06 | 4P05 |
| 29H | SAR IN4+ Low byte | 4P04 | 4P03 | 4P02 | 4P01 | 0 | 0 | 0 | 0 |
| 2AH | SAR IN4- High byte | 4N12 | 4N11 | 2N10 | 4N09 | 4N08 | 4N07 | 4N06 | 4N05 |
| 2BH | SAR IN4- Low byte | 4N04 | 4N03 | 4N02 | 4N01 | 0 | 0 | 0 | 0 |
| 2CH | SAR VBAT High byte | VB12 | VB11 | VB10 | VB09 | VB08 | VB07 | VB06 | VB05 |
| 2DH SAR VBAT Low byte | | VB04 | VB03 | VB02 | VB01 | 0 | 0 | 0 | 0 |
| | R/W | | RD |
| Default | | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

SAR Raw Data Readout.

When reading these registers, always read the high byte first. The low byte is only updated when the high byte is read.

SYSTEM DESIGN

Figure 42 shows the system connection diagram example.

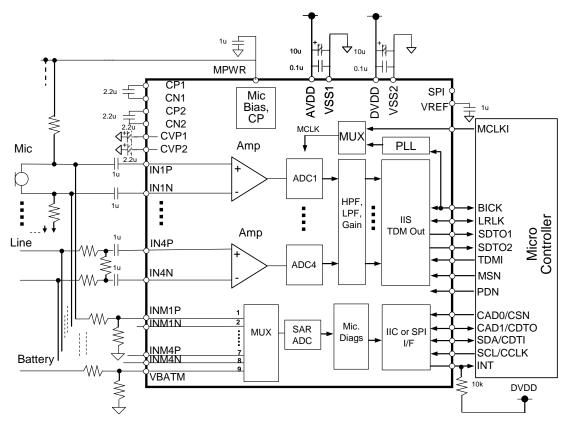


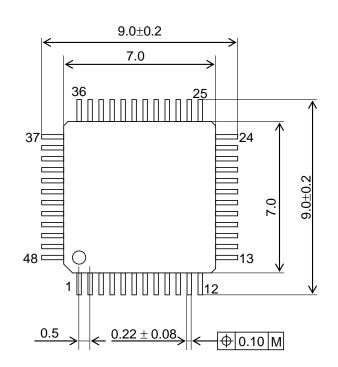
Figure 42. Typical Connection Diagram

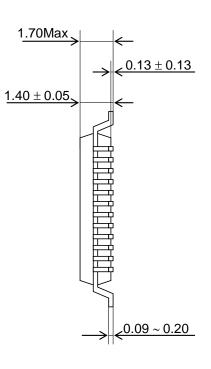
■ Grounding and Power Supply Decoupling

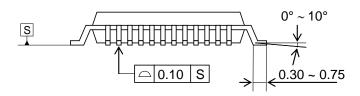
AVDD should be supplied from an analog supply unit with low impedance and be separated from system digital supply. An electrolytic capacitor of $10\mu F$ parallel with a $0.1\mu F$ ceramic capacitor should be attached between AVDD and VSS1 pins, and DVDD and VSS2 pins to eliminate the effects of high frequency noise. The $0.1\mu F$ ceramic capacitor should be placed as close to VDD (AVDD, DVDD) as possible.

PACKAGE

48pin LQFP(Unit: mm)





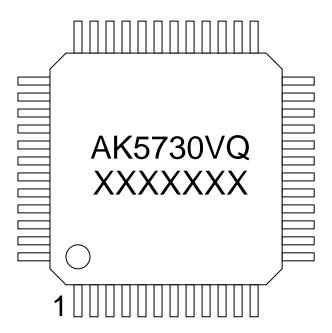


■ Package & Lead Frame Material

Package molding compound: Epoxy Lead frame material: Cu

Lead frame surface treatment: Solder (Pb free) plate

MARKING



1) Pin #1 indication

2) Marking Code: AK5730VQ

3) Date Code: XXXXXXX (7 digits)

ORDERING GUIDE

AK5730VQ AKD5730 -40 ~ +105°C

48pin LQFP (0.5mm pitch)

AKD5730 Evaluation Board for AK5730

REVISION HISTORY

| Date (Y/M/D) | Revision | Reason | Page/Line | Contents |
|--------------|----------|---------------|------------|---|
| 13/10/16 | 00 | First Edition | | |
| 13/12/19 | 01 | Specification | 11,12, 22, | TDM512 mode was deleted. |
| | | Change | 23, 24, 41 | |
| 13/07/08 | 02 | Improvement | 2 | Block Diagram was improved. |
| | | Error | 6 | Pin No.38 CVP2 |
| | | Correction | | The maximum bias voltage was changed. : $7.2V \rightarrow 14.4V$ |
| 15/11/24 | 03 | Specification | 12 | Slave TDM256 mode |
| | | Change | | SDTO Setup time BICK" \uparrow " (min.) 12ns \rightarrow 16.3ns |
| | | | | SDTO Hold time BICK" \uparrow " (min.) $10 \text{ns} \rightarrow 16.3 \text{ns}$ |
| | | | | TDMI Hold time (min.) $20 \text{ns} \rightarrow 10 \text{ns}$ |
| | | | | TDMI Setup time (min.) $20ns \rightarrow 10ns$ |
| | | | | Master TDM256 mode |
| | | | | SDTO Setup time BICK" \(^{\mathbb{n}}\)" (min.) $12\text{ns} \rightarrow 16.3\text{ns}$ |
| | | | | (max.) 20ns→ Deleted |
| | | | | SDTO Hold time BICK" \(^\mathref{n}\)" (min.) 10 ns $\rightarrow 16.3$ ns |
| | | | | TDMI Hold time $(min.)$ 20ns \rightarrow 10ns |
| | | | | TDMI Setup time (min.) 20ns → 10ns |
| | | Description | 20 | System Clock |
| | | Addition | | Add "In TDM256 mode, the master clock should be 256fs." |
| | | | 22 | Audio Serial Interface Format |
| | | | | Add "In slave mode, the MCLKI clock frequency is allowed |
| | | | | 256fs and 512fs. In master mode, the MCLKI clock |
| | | | | frequency should be 256fs." |
| | | | 24 | Add a figure of master mode to the Cascade TDM |
| | | | | Connection Diagram. |
| | | Error | 43 | Register Definitions |
| | | Correction | | Address 08H, D6 "0" → "OVTP" |
| | | | | Address 08H, D5 "OVTP1" → "OVCR2" |
| | | | 44 | Register Definitions |
| | | | | GAIN4-1 0: 1.68 Vrms $\rightarrow 1.65$ Vrms |
| | | | | $1: 0.56 \text{Vrms} \rightarrow 0.55 \text{Vrms}$ |
| | | | 46 | SYSTEM DESIGN |
| | | | | •Add a 1uF capacitor to MPWR pin |
| | | | | •MCLK → MCLKI |
| | | Description | 48 | Add ordering guide |
| | | Addition | | |

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